

P-Ch MOSFET

General Description

The WSF90P03 is the highest performance trench P-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF90P03 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

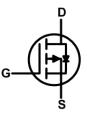
BVDSS	RDSON	ID
-30V	5mΩ	-85A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration





		Rating		
Symbol	Parameter	10s	Steady State	Units
V _{DS}	Drain-Source Voltage	-	V	
V _{GS}	Gate-Source Voltage	<u>±</u>	20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ -10V ¹	-	-85	
I₀@T₀=100°C	Continuous Drain Current, V _{GS} @ -10V ¹	-	78	А
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ -10V ¹	-25.8	-21.3	А
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ -10V ¹	-23.2	-18	А
I _{DM}	Pulsed Drain Current ²	-240		А
EAS	Single Pulse Avalanche Energy ³	408		mJ
I _{AS}	Avalanche Current	-55.4		А
P _D @T _C =25℃	Total Power Dissipation ⁴	52.1		W
P _D @T _A =25℃	Total Power Dissipation ⁴	5	2	W
T _{STG}	Storage Temperature Range	-55 to 150		°C
TJ	Operating Junction Temperature Range	-55	to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ¹		62	°C/W
R _{0JA}	Thermal Resistance Junction-Ambient 1 (t ≤10s)		25	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		2.4	°C/W

Absolute Maximum Ratings



P-Ch MOSFET

Electrical Characteristics (T _J =25	C, unless otherwise noted)
--	----------------------------

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I _D =-250uA	-30			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=-1mA		-0.018		V/℃
Б	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-30A		5	6	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-4.5V , I _D =-15A		6	8	mΩ
V _{GS(th)}	Gate Threshold Voltage		-1.0	-1.6	-2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} -V _{DS} , ID2500A		5.04		mV/℃
	Drain Source Lookage Current	$V_{\text{DS}}\text{=-}24\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\mathrm{C}$			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} = $0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-30A		26.4		S
Qg	Total Gate Charge (-4.5V)	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-15A		37		
Q _{gs}	Gate-Source Charge			23		nC
Q _{gd}	Gate-Drain Charge			14		
T _{d(on)}	Turn-On Delay Time			15		
Tr	Rise Time	$V_{DD}\text{=-}15V$, $V_{GS}\text{=-}10V$, $R_{G}\text{=}3.3\Omega,$		22		20
T _{d(off)}	Turn-Off Delay Time	I _D =-15A		85		ns
T _f	Fall Time			47		
C _{iss}	Input Capacitance			4448		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		808		pF
C _{rss}	Reverse Transfer Capacitance			521		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	V _{DD} =-25V , L=0.1mH , I _{AS} =-30A	120			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,6}	$V_G = V_D = 0V$, Force Current			-20	А
I _{SM}	Pulsed Source Current ^{2,6}				-180	А
V _{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25 $^{\circ}$ C			-1.2	V
t _{rr}	Reverse Recovery Time	-IF=-15A,dI/dt=100A/μs, Tյ=25℃		34		nS
Qrr	Reverse Recovery Charge			19		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V, L=0.1mH, I_{AS} =-30A

4.The power dissipation is limited by 150 $^\circ\!\!\mathrm{C}$ junction temperature

5. The Min. value is 100% EAS tested guarantee.

6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



WSF90P03

P-Ch MOSFET



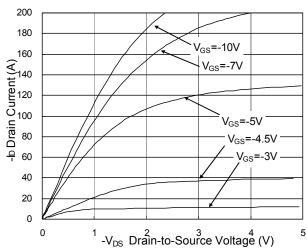


Fig.1 Typical Output Characteristics

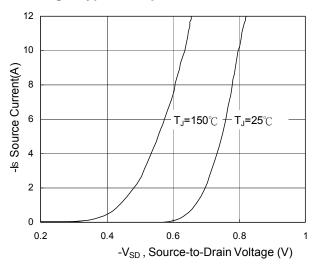
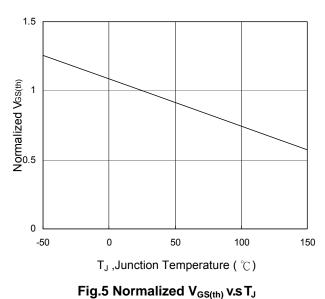
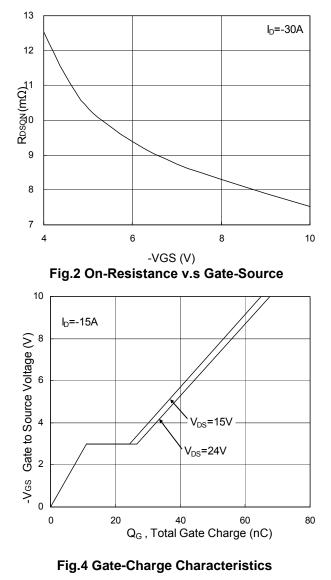


Fig.3 Forward Characteristics Of Reverse





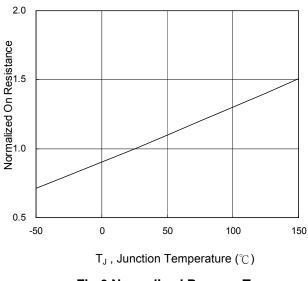


Fig.6 Normalized R_{DSON} v.s T_J



WSF90P03

P-Ch MOSFET

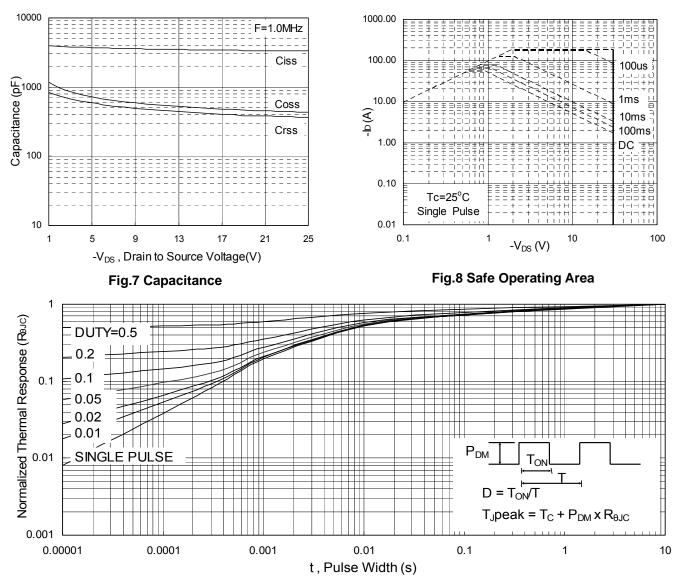
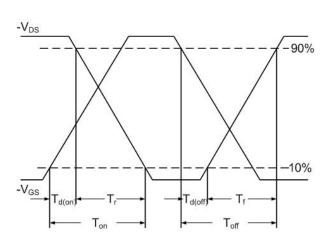


Fig.9 Normalized Maximum Transient Thermal Impedance





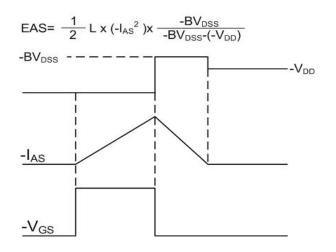


Fig.11 Unclamped Inductive Switching Waveform



Attention

1, Any and all Winsok power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your Winsok power representative nearest you before using any Winsok power products described or contained herein in such applications.

2, Winsok power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all Winsok power products described or contained herein.

3, Specifications of any and all Winsok power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

4, Winsok power Semiconductor CO., LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

5, In the event that any or all Winsok power products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

6, No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of Winsok power Semiconductor CO., LTD.

7, Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Winsok power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

8, Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the Winsok power product that you Intend to use.

9, this catalog provides information as of Sep.2014. Specifications and information herein are subject to change without notice.



单击下面可查看定价,库存,交付和生命周期等信息

>>WINSOK(微硕)